Display Elektronik GmbH

DATA SHEET

TFT MODULE

DEM 128160B TMH-PW-N (C-TOUCH)

1,8" TFT + PCT

Product Specification

Ver.: 0

Revision History

Revision	Date	Detail	Remarks
0	09.06.2017	Initial Release	-

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1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs, a touch panel and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size (Diagonal)	1.77"	-
LCD Type	TN TFT	-
Display Mode	Transmissive / Normally White	-
Resolution	128 x RGB x 160	Pixels
View Direction	6 O'clock	Best Image
Gray Scale Inversion Direction	12 O'clock	-
Module Outline	40.70 x 52.75 x 4.15 (Note1)	mm
Active Area	28.03 x 35.04	mm
Pixel Size	0.219 x 0.219	mm
Pixel Arrangement	Stripe	-
Polarizer Surface Treatment	Anti-Glare	-
Display Colors	262k	-
Interface	MCU 8-Bit-Parallel MCU	-
With or without touch panel	With Projective Capacitive Touch	-
Driver IC	ILI9163V (Ilitek)	-
Operating Temperature	-20°C to +70°C	°C
Storage Temperature	-30°C to +80°C	°C
Weight	~ 13	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

3. Absolute Maximum Ratings

Vss=0V, Ta=25°C

Item		Symbol	Min.	Max.	Unit
Supply Voltage	Logic	IOVCC	-0.3	4.6	V
Supply Voltage	Analog	VCC	-0.3	4.6	V
Storage Temperature		T _{STG}	-30	+80	°C
Operating Temperature		Тор	-20	+70	°C

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10°C, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	
Supply Voltage	Logic	IOVCC	1.65	2.8	3.3	V
Supply Voltage	Analog	VCC	2.5	2.8	3.3	V
Logic Low input voltage		VIL	GND	-	0.3*IOVCC	V
Logic High input voltage		VIH	0.7*IOVCC	-	IOVCC	V
Logic Low output voltage		Vol	GND	-	0.2*IOVCC	V
Logic High output voltage		V _{OH}	0.8*IOVCC	-	IOVCC	V
Current Consumption Logic		ICC+ IIN	_	(2)	(4)	mA
All Black	Analog	ICC+ IIIV	_	(2)	(+)	шл

5. Backlight Characteristic

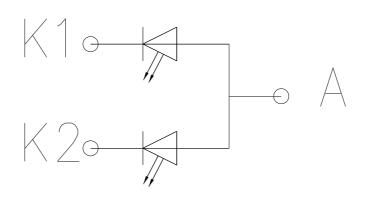
5.1. Backlight Characteristic

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF	Ta=25 °C, I _F =15mA/LED	2.8	3.1	3.3	V
Forward Current	lF	Ta=25 °C, V _F =3.1V/LED	-	30	-	mA
Power Dissipation	Pb		-	93	-	mW
LED Lifetime (25 °C)	-	-	-	30000	-	Hrs
Uniformity	Avg		-	80	-	%
Drive Method	Constant Current					
LED Configuration		2 White LED	os in Pa	rallel		

Note: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at Ta=25°C±2°C, 60%RH±5%, I_F=15mA

5.2. Backlight Characteristic



6. Touch Screen Panel Specifications

Technical Parameters:

1. Cover Glass+LOCA+ITO Glass+FPC

ITO Glass: T=0.55mm Cover Glass: 0.7mm Lead Line: FPC

IC Model: FT6336G (Focaltech)

2. Operation Voltage: 2.8-3.6 V

3. Transmittance: ≥87%4. Surface Hardness: ≥6H

5. Operation Environment: -20°C to +70°C6. Storage Environment: -30°C to +80°C

7. The GAP between LCD and CTP should be over 0.5mm

7. Optical Characteristics

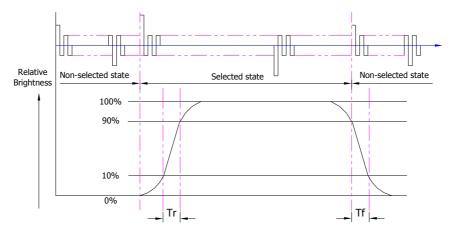
7.1. Optical Characteristics

Ta=25°C, VCC=2.8V, TN LC+ Polarizer

	Item		Symbol	Condition	S	pecification	on	Unit
	iten	l	Symbol	Condition	Min.	Тур.	Max.	Offic
	Luminan	Luminance on						
	$TFT(I_f = 15r)$	mA/LED)	Lv	Normally	230	280	-	cd/m²
ode	Contrast Ratio	(See 6.3)	CR	viewing angle	400	500	-	
Backlight On (Transmissive Mode)	Response Time (See 6.2)		TR+TF	θx = φy =0°	-	8	16	ms
E Si		Red	XR		0.553	0.603	0.653	
ans		Reu	YR		0.304	0.354	0.404	
Ë	Observation that the	Green	XG		0.246	0.296	0.346	
o	Chromaticity	Green	YG		0.571	0.621	0.671	
Ħ	Transmissive (See 6.5)	Blue	Хв		0.096	0.146	0.196	
N Sign	(366 0.3)	Diue	ΥB		0.039	0.089	0.139	
3ac		\\/bita	Xw		0.232	0.282	0.332	
		White	Yw		0.282	0.332	0.382	
		Horizontal	θх+		50	60	-	
	Viewing Angle	TIONZONIA	θх-	Center CR≥10	50	60	-	Deg.
	(See 6.4)	Vertical	φY+	Center CR210	50	60	-	Deg.
		vertical	φY-		30	40	-	
	NTSC Ratio	(Gamut)			-	60	-	%

7.2. Definition of Response Time

7.2.1. Normally Black Type (Negative)

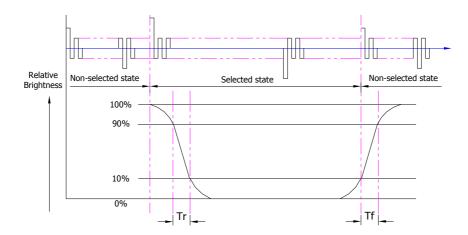


Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

7.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

7.3. Definition of Contrast Ratio

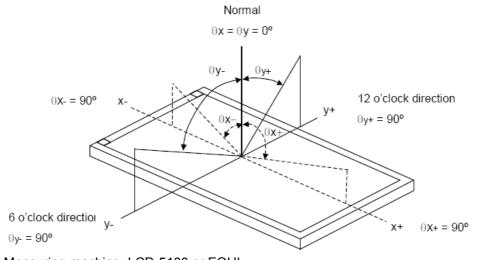
Contrast is measured perpendicular to display surface in reflective and transmissive mode.

The measurement condition is:

Measuring Equipment	Eldim or Equivalent			
Measuring Point Diameter	3mm//1mm			
Measuring Point Location	Active Area centre point			
Toot nottorn	A: All Pixels white			
Test pattern	B: All Pixel black			
Contrast setting	Maximum			

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

7.4. Definition of Viewing Angles

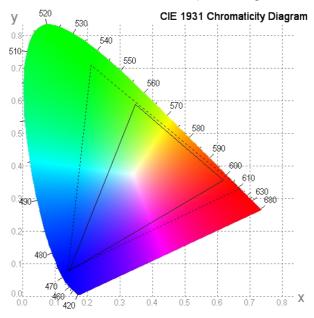


Measuring machine: LCD-5100 or EQUI

7.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

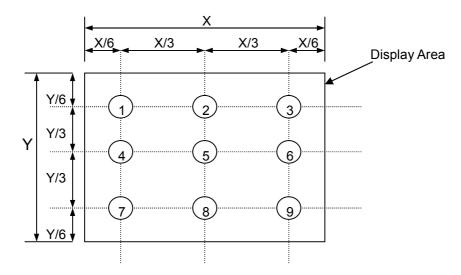


7.6. Definition of Surface Luminance, Uniformity and Transmittance

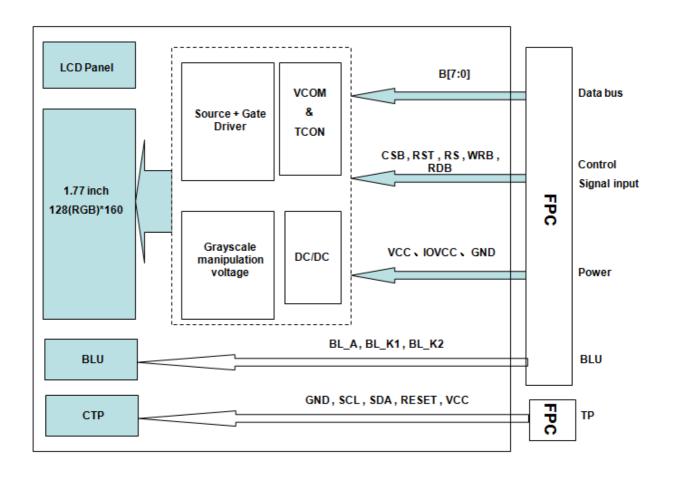
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 7.6.1. Surface Luminance: L_V = average (L_{P1} : L_{P9})
- 7.6.2. Uniformity = Minimal $(L_{P1}:L_{P9})$ / Maximal $(L_{P1}:L_{P9})$ * 100%
- 7.6.3. Transmittance = L_V on LCD / L_V on Backlight * 100%

Note: Measuring machine: BM-7



8. Block Diagram and Power Supply



9. Interface Pins Definition

9.1 TFT PIN

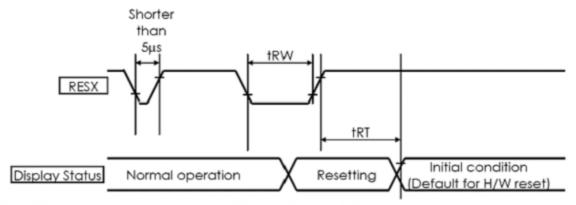
No.	Symbol	Function	Remark
1	GND	Ground	
2	IOVCC	Logic Power(1.8V)	
3	VCC	Analog Power(2.8V)	
4	CSB	Chip Select Signal	
5	RST	Reset Signal	
6	RS	Data/Command Signal	
7	WRB	Write signal	
8	RDB	Read signal	
9	DB0	Data bus	
10	DB1	Data bus	
11	DB2	Data bus	
12	DB3	Data bus	
13	DB4	Data bus	
14	DB5	Data bus	
15	DB6	Data bus	
16	DB7	Data bus	
17	BL_A	Led anode	
18	BL_K1	Led cathode	
19	BL_K2	Led cathode	
20	GND	Ground	

9.2 CTP PIN

No.	Symbol	Function	Remark
1	GND	Ground	
2	SCL	Clock	
3	SDA	Data	
4	INT	Interrupt	
5	RESET	Reset	
6	VCC	Power supply	

10. AC Characteristics

10.1.Reset timing



(VSS=0V, VDDI=1.65V to 1.95V, VPNL=2.6V to 2.9V, Ta = -30 to 70°C)

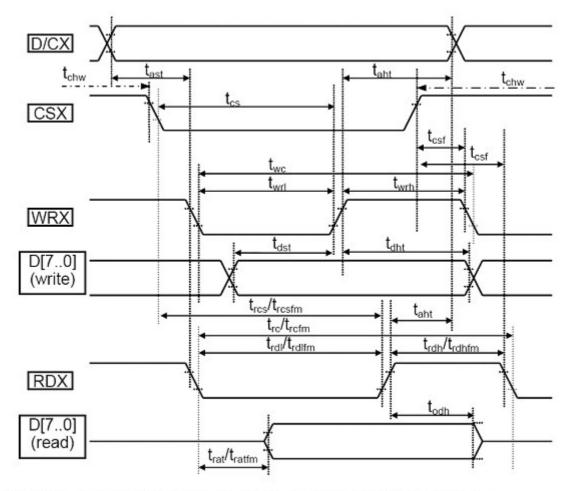
Symbol	Parameter	Related	MIN	TYP	MAX	Note	Unit
		Pins					
tRESW	*1) Reset low pulse width	RESX	10	-	-	-	μs
					5	When reset applied	ms
tREST	*0\ Deset complete width		-	-	5	during Sleep in mode	
INEST	*2) Reset complete width				100	When reset applied	ms
		-	-	-	120	during Sleep out mode	

Note

 Spike due to an electrostatic discharge on RESX line does not cause system reset according to the table below.

10.2.Interface timing

Display Module Parallel 18/16/9/8-bit Bus



Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Signal	Symbol	Parameter	min	max	unit	description
D/CX	tast	Address setup time	0	64 14	ns	(
DICX	taht	Address hold time(Write/Read)	10		ns	
	tchw	"S""H" Pulse Widtch	0	(4) N	ns	8
	tcs	Chip Select setup time (Write)	10	(c) (c)	ns	·
CSX	trcs	Chip Select setup time (Read ID)	45	20 0	ns	
	trcsfm	Chip Select setup time (Read FM)	355	20	ns	
	tcsf	Chip Select Wait time(Write/read)	10		ns	

	twc	Write cycle	66		ns		
WRX	twrh	Controlpulse H duration	15		ns		
	twrl	Control pulse L duration	15		ns		
	trc	Read cycle (ID)	160		ns	When read ID	
RDX	trdh	Control pulse H duration(ID)	90	Ç.	ns	-data	
	trdl	Control pulse L duration(ID)	45	Ģ	ns	data	
	trcfm	Read cycle (FM)	450		ns	When read from	
RDX	trdhfm	Control pulse H duration (FM)	90		ns		
	trdlfm	Control pulse L duration (FM)	355		ns	frame memory	
	tdst	Data setup time	10		ns	-	
	tdht	Data hold time	10		ns	For maximum	
D[170]	trat	Read access time (ID)		40	ns	CL = 30pF	
	tratfm	Read access time (FM)		340	ns	For minimum CL = 8pF	
	todh	Output disable time	20	80	ns	OL - opr	

Note 1: VDDI 1.65 to 3.3V, VDD=2.6 to 3.3V, AGND=GND=0V, Ta=-30 to 70 °C (to +85°C no damage)

Note 2: This input signal rise time and fall time (tr, tf) is specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for input signals

11. Quality Assurance

11.1. Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

11.2. Standard for Quality Test

11.2.1 Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

11.2.2 Sampling Criteria:

Visual inspection: AQL 1.5% Electrical functional: AQL 0.65%.

11.2.3 Reliability Test:

Detailed requirement refer to Reliability Test Specification.

11.3. Nonconforming Analysis & Disposition

- 11.3.1 Nonconforming analysis:
 - 11.3.1.1 Customer should provide overall information of non-conforming sample for their complaints.
 - 11.3.1.2 After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.
 - 11.3.1.3 If cannot finish the analysis on time, customer will be notified with the progress status.
- 11.3.2 Disposition of nonconforming:
 - 11.3.2.1 Non-conforming product over PPM level will be replaced.
 - 11.3.2.2 The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

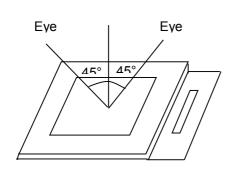
11.4. Agreement Items

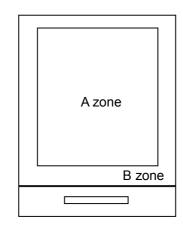
Shall negotiate with customer if the following situation occurs:

- 11.4.1 There is any discrepancy in standard of quality assurance.
- 11.4.2 Additional requirement to be added in product specification.
- 11.4.3 Any other special problem.

11.5. Standard of the Product Visual Inspection

- 11.5.1 Appearance inspection:
 - 11.5.1.1 The inspection must be under illumination about 1000 1500 lx, and the distance of view must be at 30cm ± 2cm.
 - 11.5.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.
 - 11.5.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area,



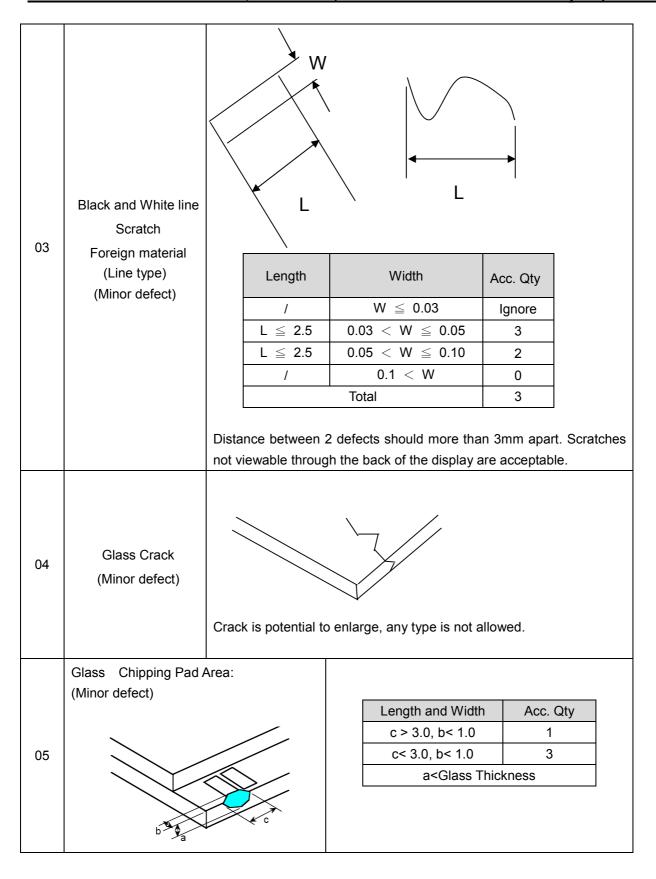


11.5.2 Basic principle:

- 11.5.2.1 A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.
- 11.5.2.2 New item must be added on time when it is necessary.

11.6. Inspection Specification

No.	Item	Criteria (Unit: mm)				
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	φ= (a + b)/2	— φ≤0.1 0.10<φ≤ 0.15<φ≤ 0.25<	i0.15 i0.25 cφ	φ≤ (ore 2 1 0 nclude
		Distance between 2	defects should more	e than 3m	m apart.	
			Display Area	То	otal	
		Bright dot	0	0		Note1
		Dark dot	N≤2	N≤	≤ 2	INOICI
02	Electrical Defect	Total dot	N≤2	N≤	≤ 2	
02	(Minor defect)	Mura	Not visible through 5% NI) filters.	Note 2
		Remark: 1. Bright dot caused	l by scratch and fore	eign objec	et accords	to item 1.



	Glass Chipping Rear of Pad Area: (Minor defect)		
	(Willion defect)	Length and Width	Acc. Qty
		c > 3.0, b< 1.0	1
06		c< 3.0, b< 1.0	2
		c< 3.0, b< 0.5	4
	c	a <glass td="" thick<=""><td>ness</td></glass>	ness
	b ga		
	Glass Chipping Except Pad Area: (Minor defect)		
	(Willion defect)	Length and Width	Acc. Qty
		c > 3.0, b< 1.0	1
07		c< 3.0, b< 1.0	2
	b	c< 3.0, b< 0.5	4
	₩ Çc	a <glass td="" thick<=""><td>rness</td></glass>	rness
	a ↑	_	
	Glass Corner Chipping: (Minor defect)	Longth and Width	Ass Ohi
		Length and Width	Acc. Qty
08		c < 3.0, b< 3.0 a <glass td="" thick<=""><td>Ignore</td></glass>	Ignore
08	ba		
	Glass Burr:		
	(Minor defect)		
		Length	Acc. Qty
		F < 1.0	Ignore
09	F		
		Glass burr don't affect ass dimension.	semble and module

10	FPC Defect: (Minor defect)		10.1 Dent, pinhole (w: circuitry width. 10.2 Open circuit 10.3 No oxidation.) is unacceptable.	
11	Bubble on Polarizer (Minor defect)		Diameter φ≤0.20 0.20 <φ≤0.30 0.30 <φ≤0.50 0.50 < φ	Acc. Qty Ignore 4 1 None	
12	Dent on Polarizer (Minor defect)		Diameter φ≤0.20 0.20 <φ≤0.30 0.30 <φ≤0.50 0.50 < φ	Acc. Qty Ignore 4 1 None	
13	Bezel	13.1 No rust, distortion on the Bezel.13.2 No visible fingerprints, stains or other contamination.			on.
14	Touch Panel	D: Diameter W: width L: length 14.1 Spot: D<0.25 is acceptable 0.25≤D≤0.4 2dots are acceptable and the distance between defects should mo than 10 mm. D>0.4 is unacceptable 14.2 Dent: D>0.40 is unacceptable 14.3 Scratch: W≤0.03, L≤10 is acceptable, 0.03 <w≤0.10, 10="" 2="" acceptable="" between="" defects="" distance="" is="" l≤10="" mm.="" more="" should="" than="" w="">0.10 is unacceptable.</w≤0.10,>			ects should more
15	РСВ	15.1 No distortion or contamination on PCB terminals. 15.2 All components on PCB must same as documented on the BOM/component layout. 15.3 Follow IPC-A-600F.			

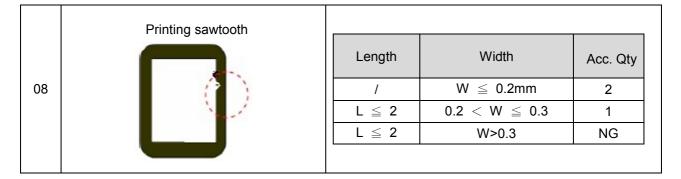
16	Soldering	Follow IPC-A-610C standard
17	Electrical Defect (Major defect)	The below defects must be rejected. 17.1 Missing vertical / horizontal segment, 17.2 Abnormal Display. 17.3 No function or no display. 17.4 Current exceeds product specifications. 17.5 LCD viewing angle defect. 17.6 No Backlight. 17.7 Dark Backlight. 17.8 Touch Panel no function.

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

Inspection Specification for the Capacitive Touch Panel

ilishe	ction Specification for the Capacitive Touch P	anei			
01	Chipping Pad Area(Not include the cover lens): (Minor defect)		o is seriously influence t e is not allowed.	the product's fui	nction,
02	Chipping Except Pad Area(Not include the cover lens): (Minor defect)		Length and Width c< 1.5, b< 1 a<1/2 Glass Th	Acc. Qty N≤5 ickness	
03	Corner Chipping(Not include the cover lens): (Minor defect)		Length and Width c < 1.5, b< 0.5 a<1/2 Glass Th	Acc. Qty Ignore ickness	

04	Crack: (Minor defect)	Crack is	s poter	ntial to enlarge, any	type is	not allowed.
05	Cover lens must be without any chips, o					the front.
		D: Diam	eter \	W: width L: length		
				Diameter	Acc. (Qty
				D < 0.20	Igno	ore
		Active A	rea:			
	Same/Different color spot			Diameter	Acc. (Qty
			0.2	$0 < D \leq 0.30$	2	
06			0.3	$0.30 < D \leq 0.50$		
00		D>0.5		NO	NG	
		Viewing	Area :			
				Diameter	Acc. (Qty
			D<0.20		Ignor	e
			$0.20 < D \leq 0.5$		3	
				D>0.5	NO	3
		Distance between 2 defects should more than15mm				than15mm
	<u> </u>	apart.				
	Cover lens line Scratch					
		Lenç	gth	Width		Acc. Qty
	\ w	1		W ≦ 0.08mr		Ignore
	*/ *	L ≦ 5		$0.08 < W \le 0.15$		2
07	_ /	L ≦	3	$0.15 < W \le 0.20$		1 NG
	\sim	L>:	5	W>0.2		NG
	, •	L		een 2 defects shoul	d more	
		apart.				



11.7. Classification of Defects

- 11.7.1 Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.
- 11.7.2 Two minor defects are equal to one major in lot sampling inspection.

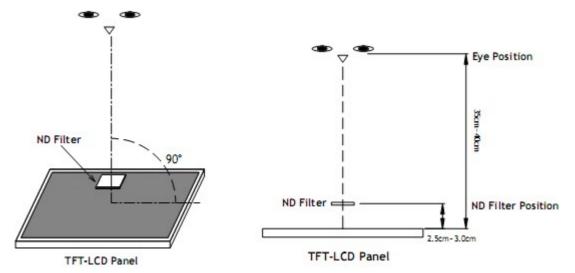
11.8. Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

11.9. Packaging

- 11.9.1 There should be no damage of the outside carton box, each packaging box should have one identical label.
- 11.9.2 Modules inside package box should have compliant mark.
- 11.9.3 All direct package materials shall offer ESD protection

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

12. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	+70°C, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20°C, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity	+50°C, 90%RH, 96Hrs	2	GB/T2423.3 -2006
4	High Temperature Storage	+80°C, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-30°C, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test	-20°C, 60min~+70°C, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	2	GB/T5170.14 -2009
8	Electrical Static Discharge	Air: \pm 8KV 150pF/330 Ω 5 times	2	GB/T17626.2 -2006
	Lieunical Static Discharge	Contact: \pm 4KV 150pF/330 Ω 5 times		
9	Drop Test (Packaged) Height:80 cm,1 corner, 3 edges, 6 surfaces.		GB/T2423.8 -1995	

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

13. Precautions and Warranty

13.1. Safety

- 13.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 13.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

13.2. Handling

- 13.2.1. Reverse and use within ratings in order to keep performance and prevent damage.
- 13.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

13.3. Storage

13.3.1 Do not store the LCD module beyond the specified temperature ranges.

13.4. Metal Pin (Apply to Products with Metal Pins)

13.4.1. Pins of LCD and Backlight

13.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

13.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

Maximum Solder Temperature: 370 ℃

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20 ℃

Typical Soldering Time: ≤3s

13.4.1.3. Solder Wetting



Solder Pin Lea

13.4.2. Pins of EL

13.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.

13.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.

13.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290°C

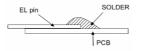
Typical Soldering Time: ≤2s

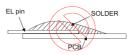
Minimum solder distance from EL lamp (body):2.0mm

13.4.2.4. No horizontal press on the EL leads during soldering.

13.4.2.5. 180° bend EL leads three times is not allowed.

13.4.2.6. Solder Wetting





Recommended

Not Recommended

13.4.2.7. The type of the solder iron:





Recommended

Not Recommended

13.4.2.8. Solder Pad



13.5. Operation

13.5.1. Do not drive LCD with DC voltage

13.5.2. Response time will increase below lower temperature

13.5.3. Display may change color with different temperature

13.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".

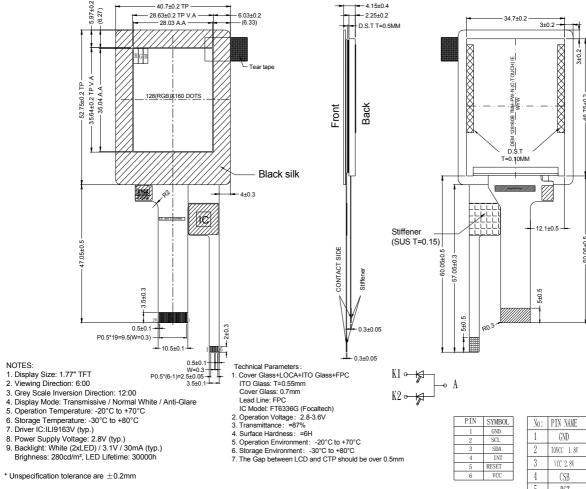
13.6. Static Electricity

- 13.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 13.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 13.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

13.7. Limited Warranty

- 13.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 13.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 13.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

14. Outline Drawing



No:	PIN NAME
1	GND
2	IOVOC 1.8V
3	VOC 2.8V
4	CSB
5	RST
6	RS
7	WRB
8	RDB
9	DB0
10	DB1
11	DB2
12	DB3
13	DB4
14	DB5
15	DB6
16	DB7
17	BL_A
18	BL_K1
19	BL_K2
20	GND